



# Diseño y Optimización de una Cámara de Simulación de Atmósfera Espacial

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DE MÁLAGA

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## Contenido

- **Descripción general**
- **Fundamento teórico**
- **Posibles soluciones**
- **Geometría**
- **Interfaces físicas y condiciones de contorno**
- **Malla**



# Contenido

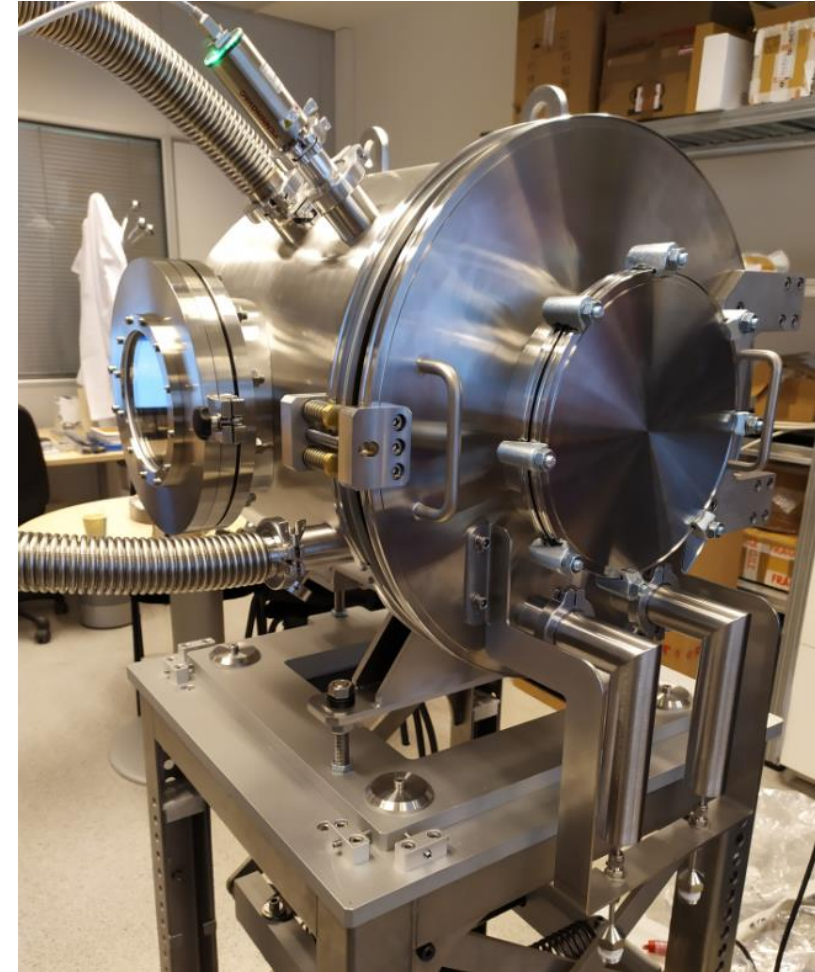
- Estudios
- Resultados
- Elección en base a los resultados
- Simplificación del Modelo
- App

## Descripción general

- Simulación de condiciones espaciales
- Temperaturas
- Presión
- Radiación Solar



**PROACTIVE**  
R&D



Ejemplo de Cámara de Simulación  
desarrollada por **PROACTIVE R&D**

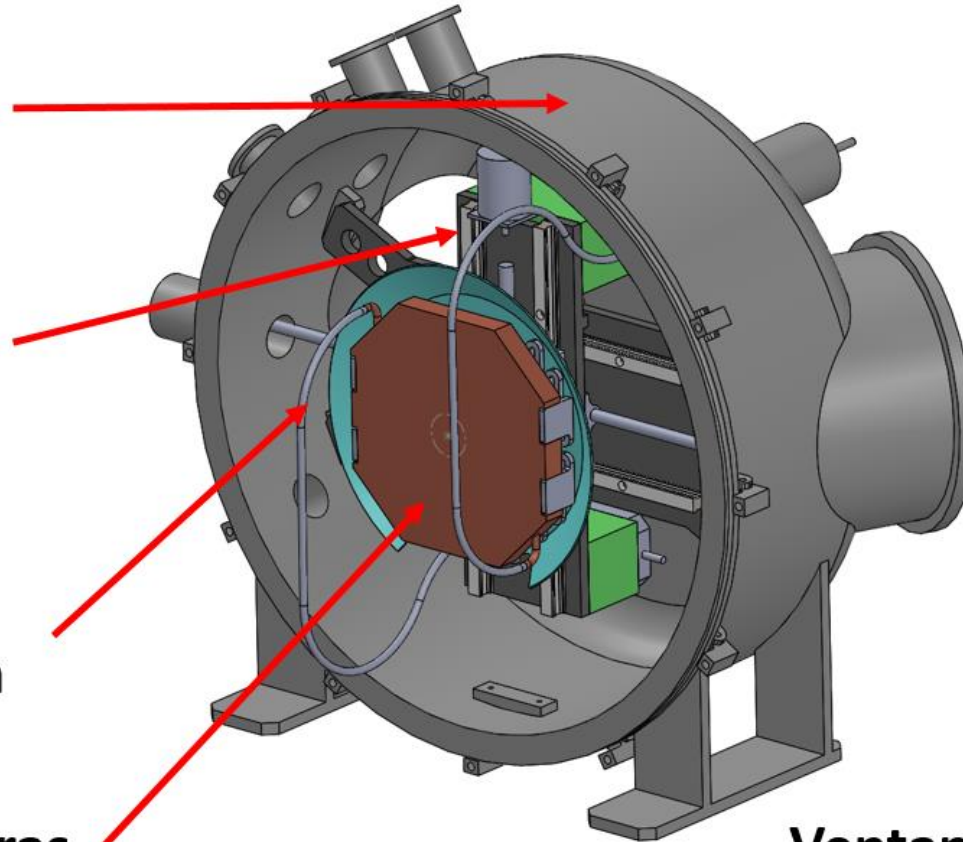
## Descripción general

**Cámara de vacío**

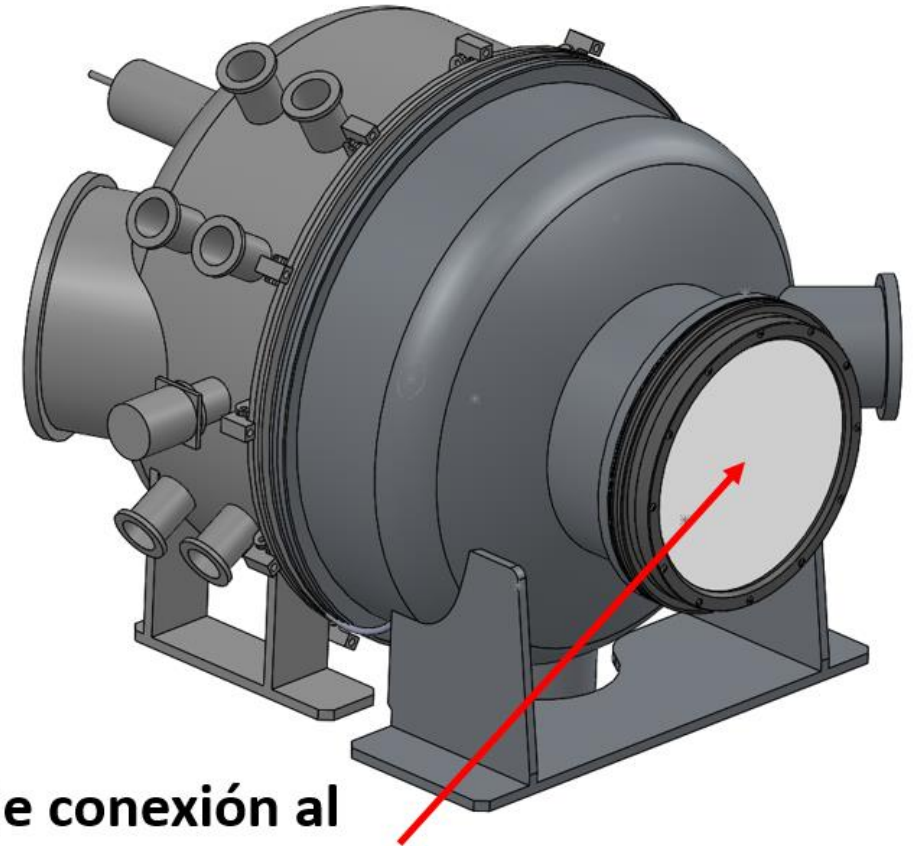
**Sistema de traslación**

**Sistema de refrigeración**

**Porta Muestras**



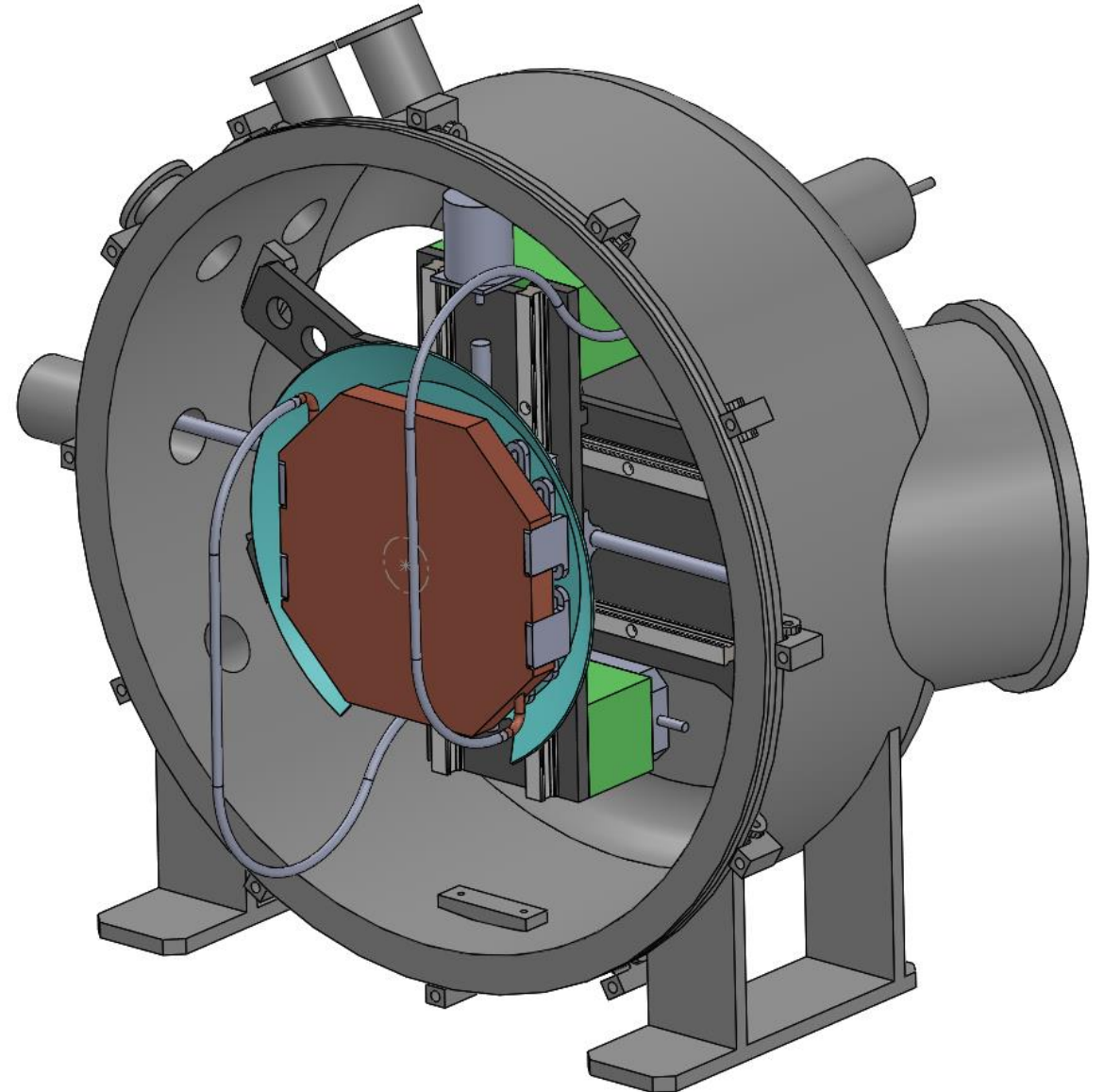
**Ventana de conexión al  
acelerador de partículas**



## Descripción general

- Alto Vacío ( $\sim 10e-6$  mbar)
- Rango de temperaturas controlable entre -150 y 200 °C
- Sistema de traslación XY del porta muestras, con un rango de movimiento de 200 mm por eje.

**El presente trabajo se centra en el estudio del Rango frío de temperaturas.**



## Fundamento teórico – Transferencia de Calor

- Convección - Ley de Newton:

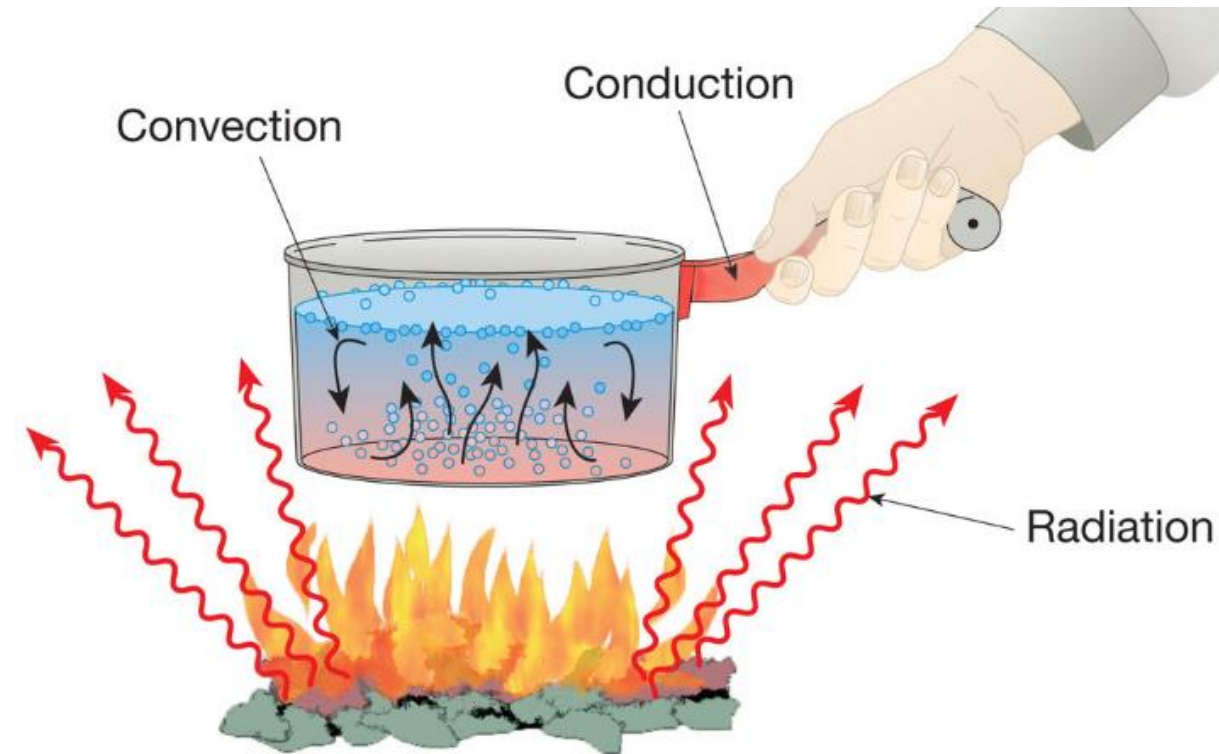
$$\dot{Q} = A \cdot h \cdot (T_w - T_\infty)$$

- Conducción - Ley de Fourier:

$$\frac{\partial^2 T}{\partial x^2} + \frac{\partial^2 T}{\partial y^2} + \frac{\partial^2 T}{\partial z^2} + \frac{G}{k} = \frac{1}{\alpha} \frac{\partial T}{\partial t}$$

- Radiación - Ley de Stefan-Boltzmann:

$$E_b(T) = \sigma T^4$$



## Fundamento teórico – Dinámica de Fluidos

- Número de Reynolds

$$Re = \frac{Vs \cdot Dh}{\nu} \quad \nu = \frac{\mu}{\rho}$$

$Vs$  - Velocidad del fluido

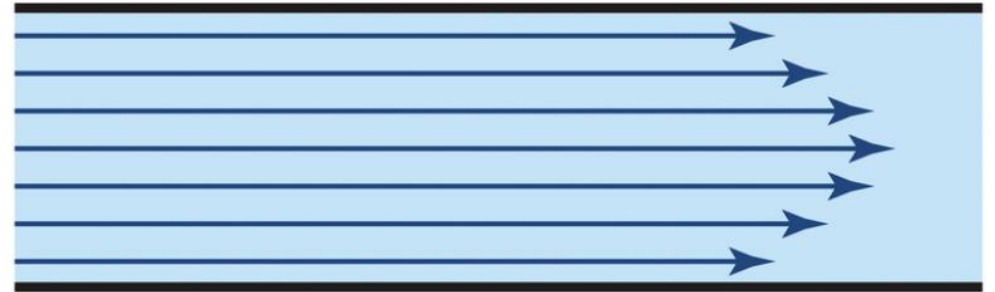
$Dh$  - Diámetro hidráulico del circuito de refrigeración

$\nu$  - Viscosidad cinemática

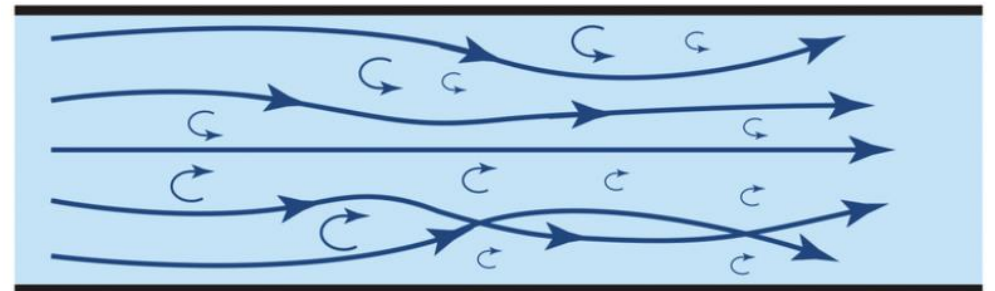
$\mu$  - Viscosidad dinámica

$\rho$  - Densidad.

Laminar Flow



Turbulent Flow





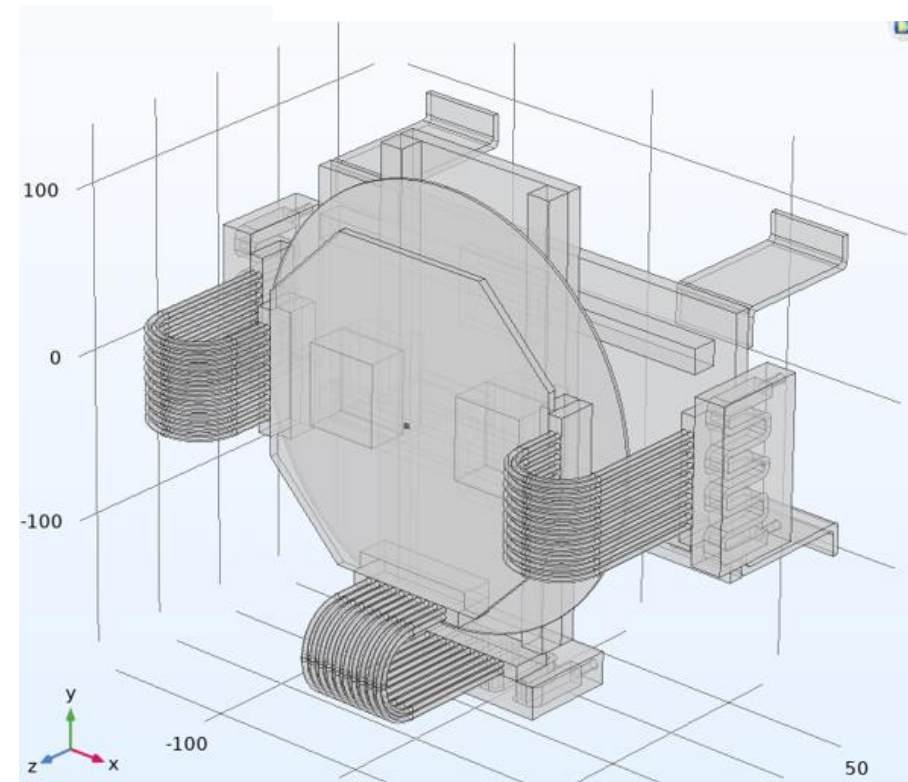
## Posibles soluciones – Thermal Links

### Ventajas:

- Muy buena conductividad térmica.
- Elementos muy flexibles, ideales para integrarlos junto con el sistema de traslación.
- El circuito de refrigeración permanece fijo, con uniones soldadas entre elementos, ideal para entornos de Alto Vacío.

### Desventajas:

- Enfriamientos más lentos.



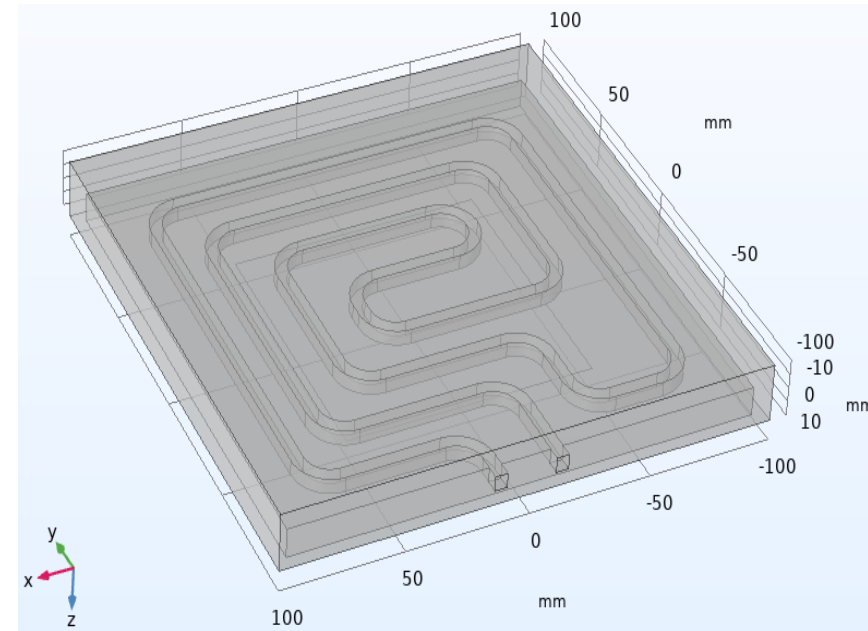
## Posibles soluciones – Refrigeración directa

### Ventajas:

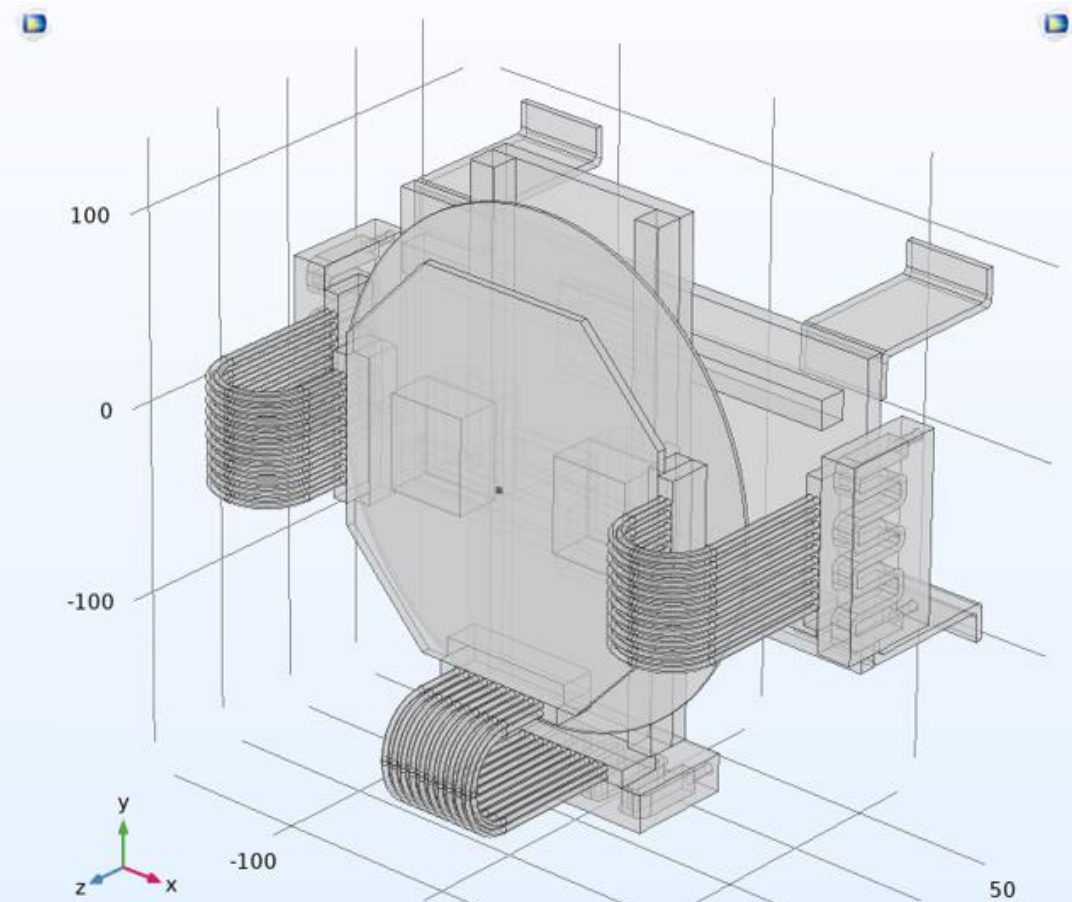
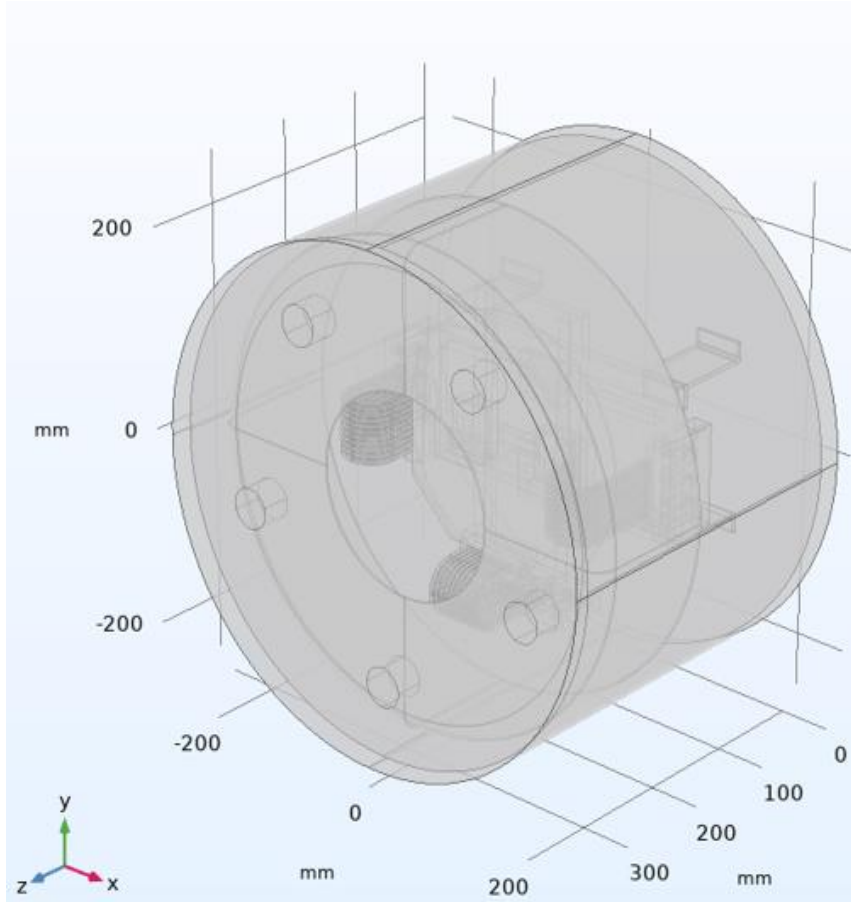
- Enfriamientos más rápidos.

### Desventajas:

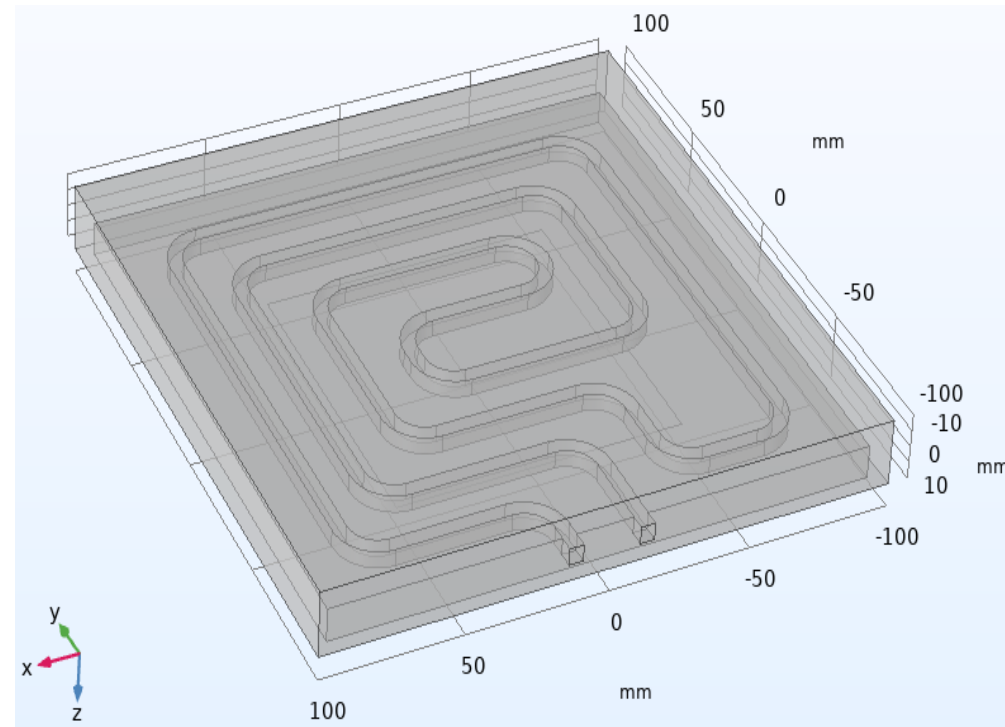
- Suelen ser más rígidas que los Thermal Links.
- Mayor número de conexiones en el circuito de refrigeración, por lo tanto mayor riesgo de fugas y pérdida de vacío.



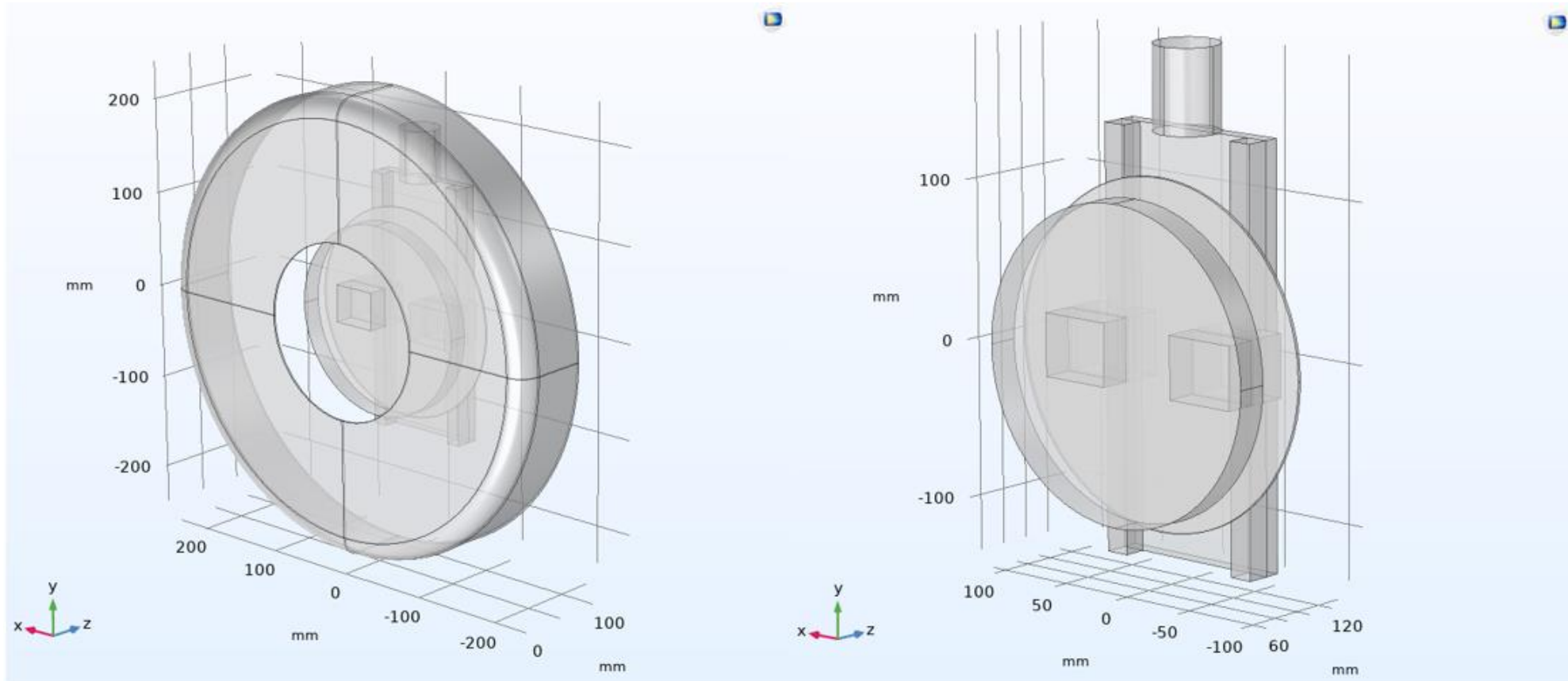
# Geometría – Thermal Links



# Geometría – Refrigeración directa



# Geometría – Estimación de la Radiación Térmica

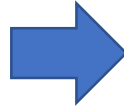




# Interfaz física – Thermal Links



- Fluid Properties 1
    - Initial Values 1
    - Wall 1
    - Inlet 1
    - Outlet 1
    - Equation View
  - Heat Transfer in Solids and Fluids (*ht*)
    - Solid 1
    - Fluid 1
    - Initial Values 1
    - Thermal Insulation 1
    - Inflow - Inferior
    - Inflow - Derecha
    - Inflow - Izquierda
    - Inflow 2
    - Outflow 1
    - Vessel Heat Flux
    - Equation View
  - Surface-to-Surface Radiation (*rad*)
    - Diffuse Surface 1
    - Initial Values 1
    - Equation View
  - Multiphysics
    - Nonisothermal Flow 1 (*nitf1*)
    - Heat Transfer with Surface-to-Surface Radiation 1 (*htrad1*)



### Inflow Inferior Settings

Upstream Properties

Upstream temperature:

$T_{ustr}$  User defined  K

### Inflow Derecha Settings

Upstream Properties

Upstream temperature:

$T_{ustr}$  User defined  K

### Inflow Izquierda Settings

Upstream Properties

Upstream temperature:

$T_{ustr}$  User defined  K

## Vessel Heat Flux Settings

Heat Flux

General inward heat flux  
 Convective heat flux

$$q_0 = h \cdot (T_{ext} - T)$$

Heat transfer coefficient:

External natural convection

Vertical wall

Wall height:

L  m

Fluid:

Air

Absolute pressure:

$p_A$  User defined  Pa

External temperature:

$T_{ext}$  User defined  K

Heat rate  

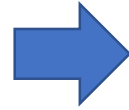
$$q_0 = \frac{P_0}{A}$$





# Interfaz física – Estimación de la Radiación Térmica

- Heat Transfer in Solids (*ht*)
  - Solid 1
  - Initial Values 1
  - Thermal Insulation 1
  - Temperature 1
  - Thermal Insulation 2
  - Equation View
- Surface-to-Surface Radiation (*rad*)
  - Diffuse Surface 1
  - Initial Values 1
  - Equation View
- Multiphysics
  - Heat Transfer with Surface-to-Surface Radiation 1 (*htrrad1*)



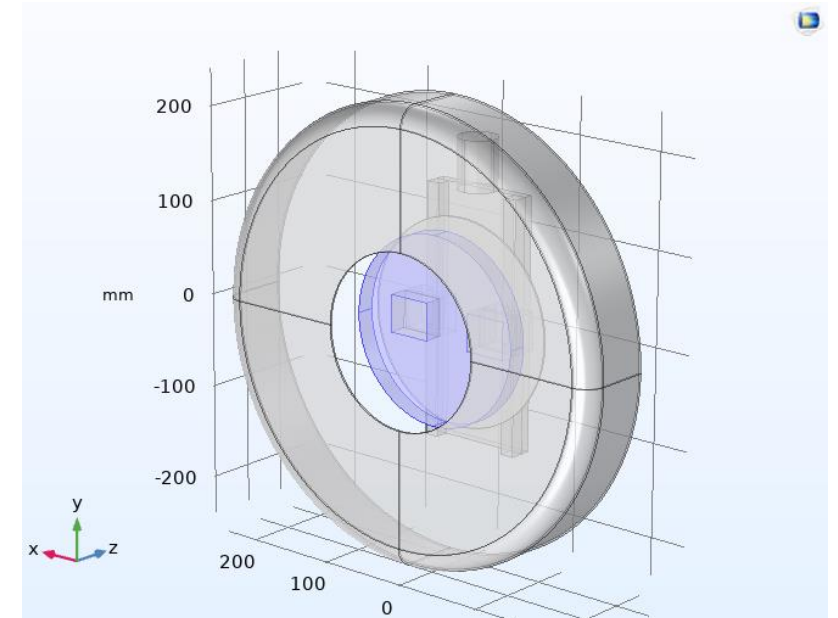
## Temperature Settings

Temperature

Temperature:

$T_0$  User defined

100[K] K



# Interfaz física – Estimación de la Radiación Térmica

- Heat Transfer in Solids (*ht*)
    - Solid 1
    - Initial Values 1
    - Thermal Insulation 1
    - Temperature 1
    - Thermal Insulation 2
    - Equation View
  - Surface-to-Surface Radiation (*rad*)
    - Diffuse Surface 1
    - Initial Values 1
    - Equation View
  - Multiphysics
    - Heat Transfer with Surface-to-Surface Radiation 1 (*htrrad1*)



### Diffuse Surface Settings

**Ambient**

— Ambient temperature \_\_\_\_\_

Define ambient temperature on each side

Ambient temperature:

$T_{amb}$  User defined K

293.15[K]

— Ambient emissivity \_\_\_\_\_

Define ambient emissivity on each side

Ambient emissivity:

Blackbody

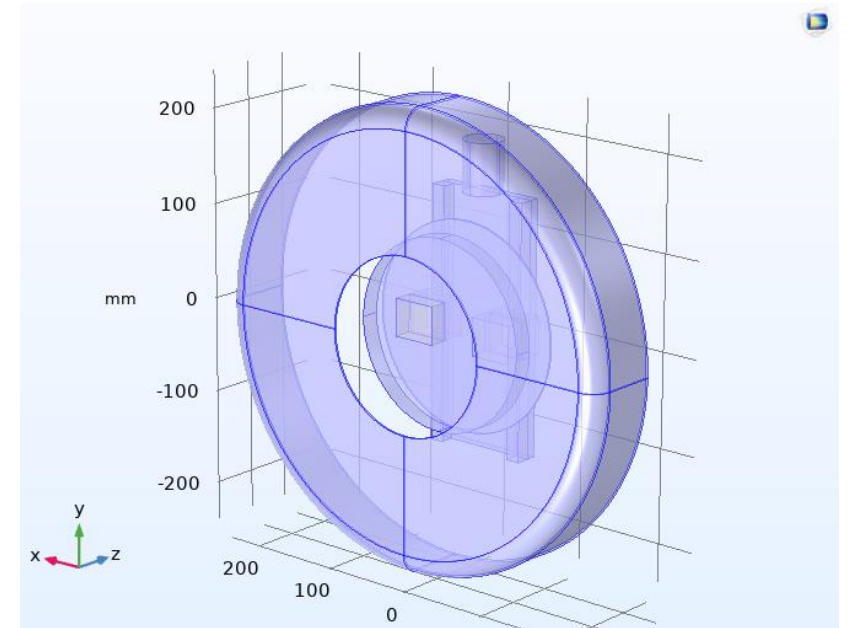
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**Surface Emissivity**

Define surface emissivity on each side

Surface emissivity:

$\epsilon$  From material





# Interfaz física – Refrigeración directa

- Turbulent Flow, k- $\omega$  (*spf*)
    - Fluid Properties 1
    - Initial Values 1
    - Wall 1
    - Inlet 1
    - Outlet 1
    - Equation View
  - Heat Transfer in Solids and Fluids (*ht*)
    - Solid 1
    - Fluid 1
    - Initial Values 1
    - Thermal Insulation 1
    - Inflow - Initial Conditions
    - Inflow - T input
    - Outflow 1
    - Resistors - Heat Flux
    - Radiation - Heat Flux
    - Thermal Insulation 2
    - PCB - Heat Flux
    - Equation View
  - Heat Transfer in Solids 2 (*ht2*)
    - Solid 1
    - Initial Values 1
    - Thermal Insulation 1
    - Resistors - Heat Flux
    - Radiation - Heat Flux
    - Thermal Insulation 2
    - Convective Heat Flux - Ref Power 35 m/s
    - Convective Heat Flux - Ref Power 55 m/s
    - PCB Heat Flux
    - Equation View
  - Multiphysics
    - Nonisothermal Flow 1 (*nitf1*)



### Turbulent Flow Settings

**Physical Model**

Compressibility:  
Weakly compressible flow

**Turbulence**

Turbulence model type:  
RANS

Turbulence model:  
k- $\omega$

Wall treatment:  
Wall functions

### Wall Settings

**Boundary Condition**

Wall condition:  
No slip

Apply wall roughness

Roughness model:  
Sand roughness

Equivalent sand roughness height:  
 $k_{seq}$  0.0015[mm] m

### Inlet Settings

**Boundary Condition**

Fully developed flow

**Fully Developed Flow**

Average velocity

Flow rate

Average pressure

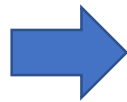
Average velocity:  
 $U_{av}$   $V_{in}$  m/s

**$V_{in} = 15 - 75 \text{ m/s}$**



# Interfaz física – Refrigeración directa

- Turbulent Flow, k- $\omega$  (*spf*)
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    - Convective Heat Flux - Ref Power 55 m/s
    - PCB Heat Flux
    - Equation View
  - Multiphysics
    - Nonisothermal Flow 1 (*nitf1*)



## Inflow Settings

Upstream Properties

Upstream temperature:

$T_{ustr}$  User defined

$T_{in} \cdot \text{step1}(t[1/h]) + T_{amb} \cdot (1 - \text{step1}(t[1/h]))$  K

Specify upstream absolute pressure

## Resistors - Heat Flux Settings

Heat Flux

General inward heat flux

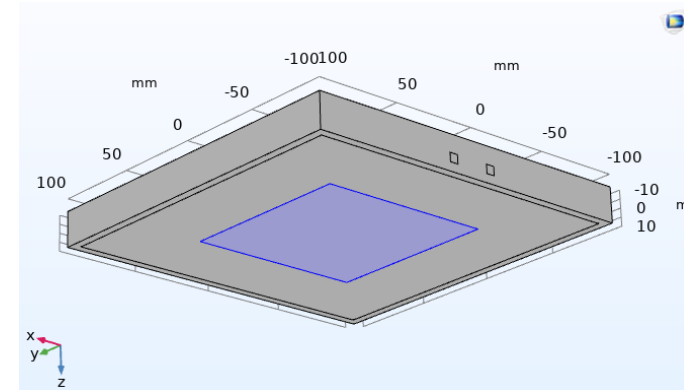
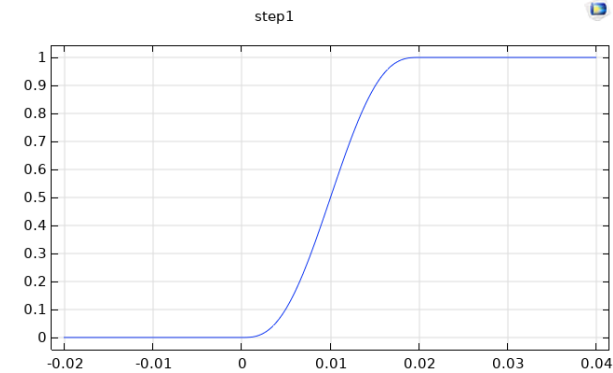
Convective heat flux

Heat rate

$q_0 = h \cdot (T_{ext} - T)$

$q_0 = \frac{P_0}{A}$

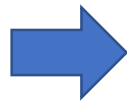
$P_0$  P\_Res\*step1(t[1/h]) W





# Interfaz física – Refrigeración directa

- ▶ Turbulent Flow, k- $\omega$  (*spf*)
  - ▶ Fluid Properties 1
  - ▶ Initial Values 1
  - ▶ Wall 1
  - ▶ Inlet 1
  - ▶ Outlet 1
  - ▶ Equation View
- ▶ Heat Transfer in Solids and Fluids (*ht*)
  - ▶ Solid 1
  - ▶ Fluid 1
  - ▶ Initial Values 1
  - ▶ Thermal Insulation 1
  - ▶ Inflow - Initial Conditions
  - ▶ Inflow - T input
  - ▶ Outflow 1
  - ▶ Resistors - Heat Flux
  - ▶ Radiation - Heat Flux
  - ▶ Thermal Insulation 2
  - ▶ PCB - Heat Flux
  - ▶ Equation View
- ▶ Heat Transfer in Solids 2 (*ht2*)
  - ▶ Solid 1
  - ▶ Initial Values 1
  - ▶ Thermal Insulation 1
  - ▶ Resistors - Heat Flux
  - ▶ Radiation - Heat Flux
  - ▶ Thermal Insulation 2
  - ▶ Convective Heat Flux - Ref Power 35 m/s
  - ▶ Convective Heat Flux - Ref Power 55 m/s
  - ▶ PCB Heat Flux
  - ▶ Equation View
- ▶ Multiphysics
  - ▶ Nonisothermal Flow 1 (*nitf1*)



## Radiation Heat Flux Settings

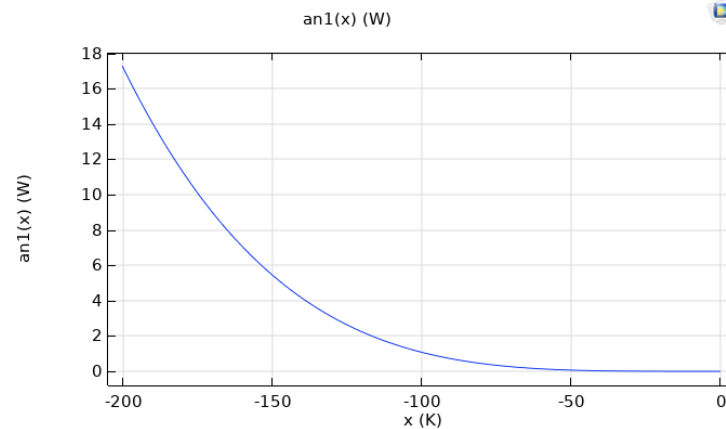
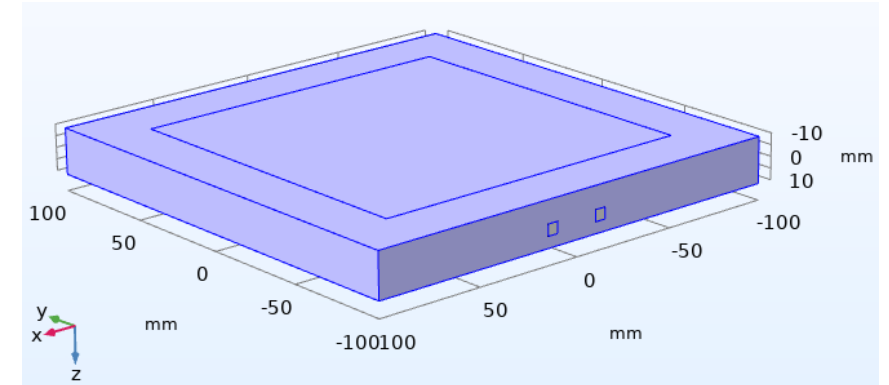
Heat Flux

General inward heat flux  
 Convective heat flux  
 Heat rate

$$q_0 = h \cdot (T_{ext} - T)$$

$$q_0 = \frac{P_0}{A}$$

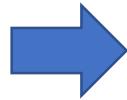
$P_0$   W





# Interfaz física – Refrigeración directa

- Turbulent Flow, k- $\omega$  (*spf*)
    - Fluid Properties 1
    - Initial Values 1
    - Wall 1
    - Inlet 1
    - Outlet 1
    - Equation View
  - Heat Transfer in Solids and Fluids (*ht*)
    - Solid 1
    - Fluid 1
    - Initial Values 1
    - Thermal Insulation 1
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    - Resistors - Heat Flux
    - Radiation - Heat Flux
    - Thermal Insulation 2
    - PCB - Heat Flux
    - Equation View
  - Heat Transfer in Solids 2 (*ht2*)
    - Solid 1
    - Initial Values 1
    - Thermal Insulation 1
    - Resistors - Heat Flux
    - Radiation - Heat Flux
    - Thermal Insulation 2
    - Convective Heat Flux - Ref Power 35 m/s
    - Convective Heat Flux - Ref Power 55 m/s
    - PCB Heat Flux
    - Equation View
  - Multiphysics
    - Nonisothermal Flow 1 (*nitf1*)



## PCB Heat Flux Settings

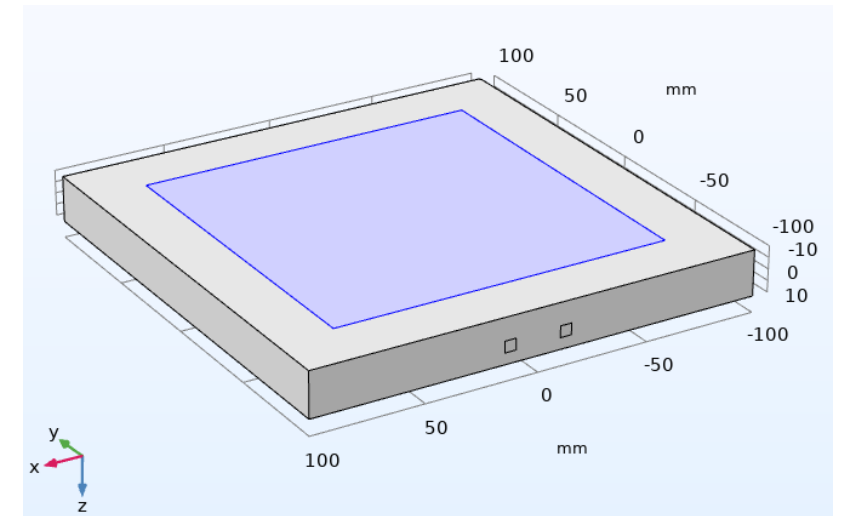
Heat Flux

General inward heat flux  
 Convective heat flux  
 Heat rate

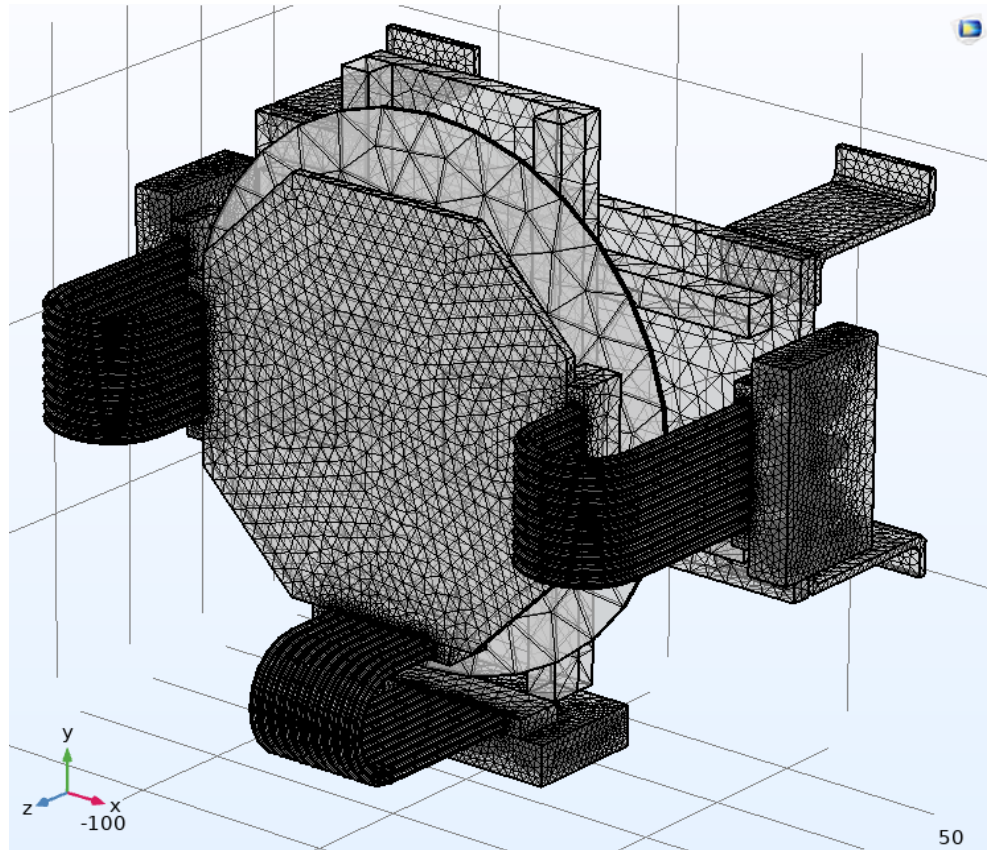
$$q_0 = h \cdot (T_{\text{ext}} - T)$$

$$q_0 = \frac{P_0}{A}$$

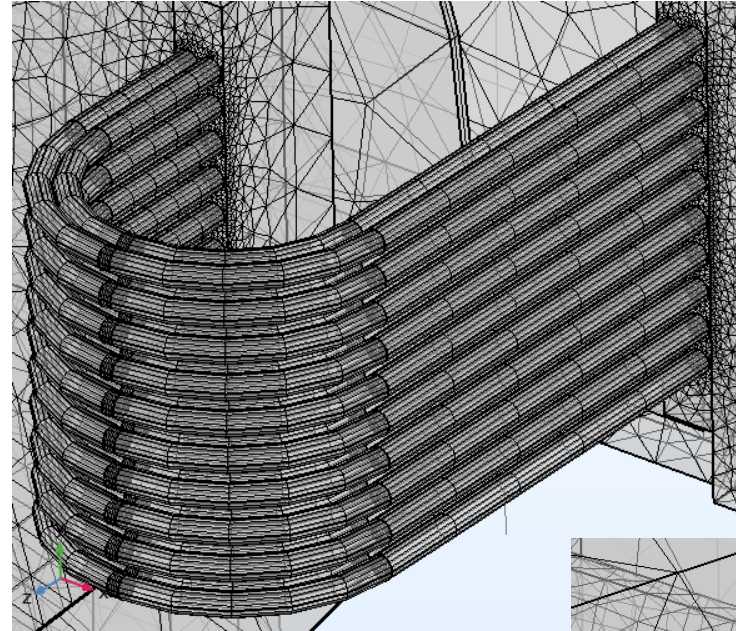
$P_0$   W



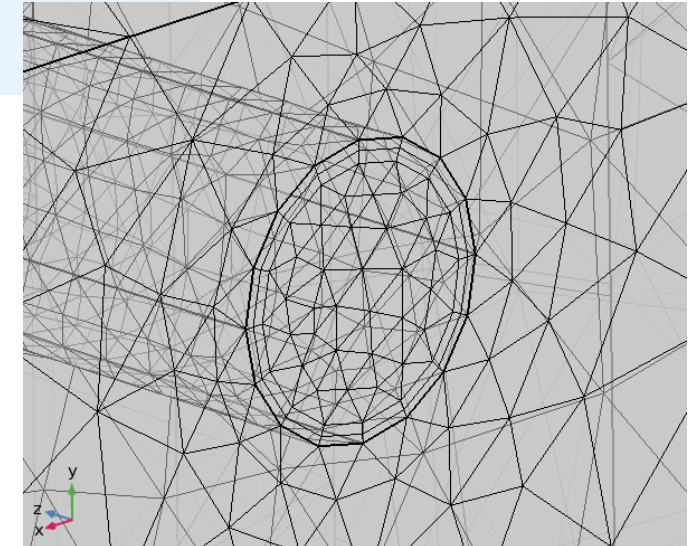
# Malla - Thermal Links



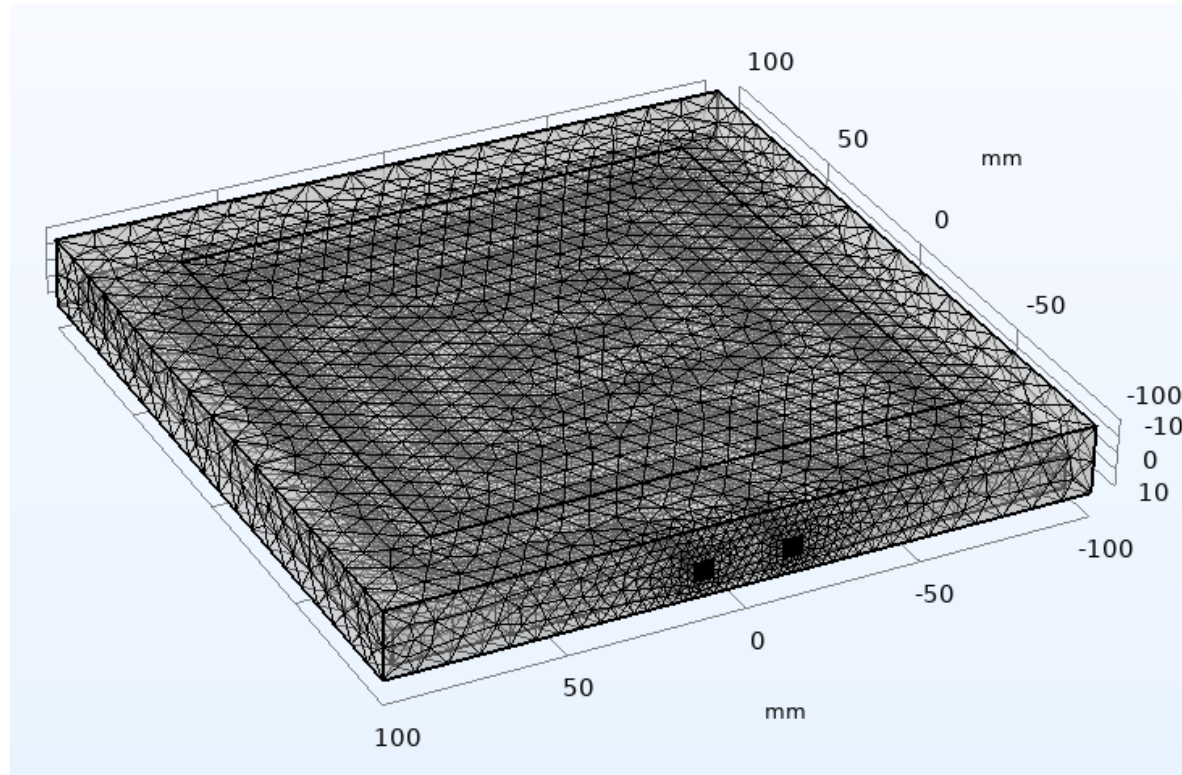
Swept



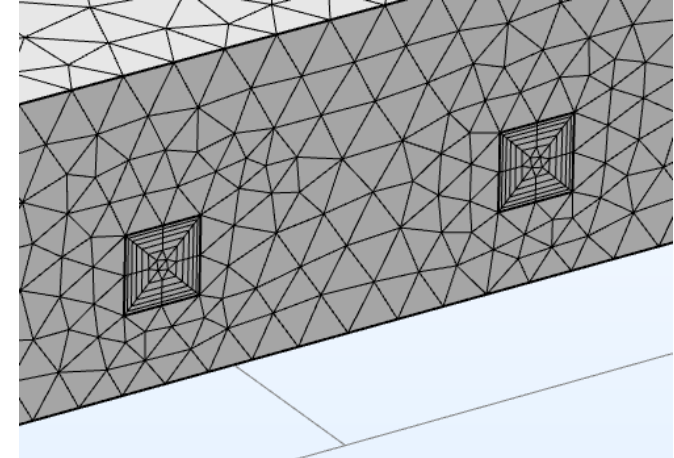
Boundary Layer



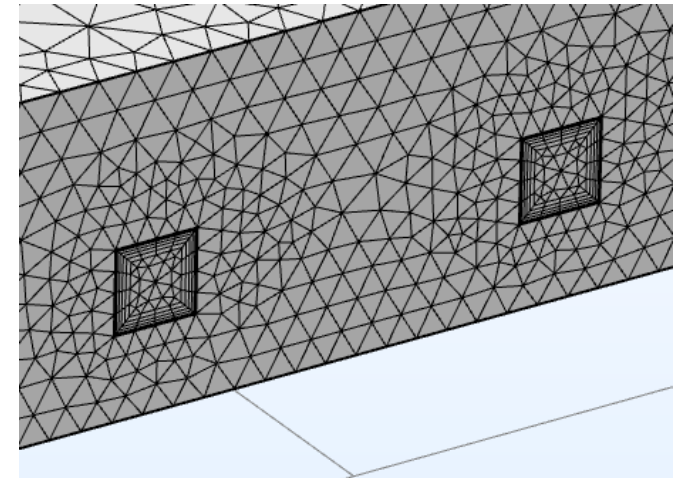
# Malla – Refrigeración directa



**Malla Normal**



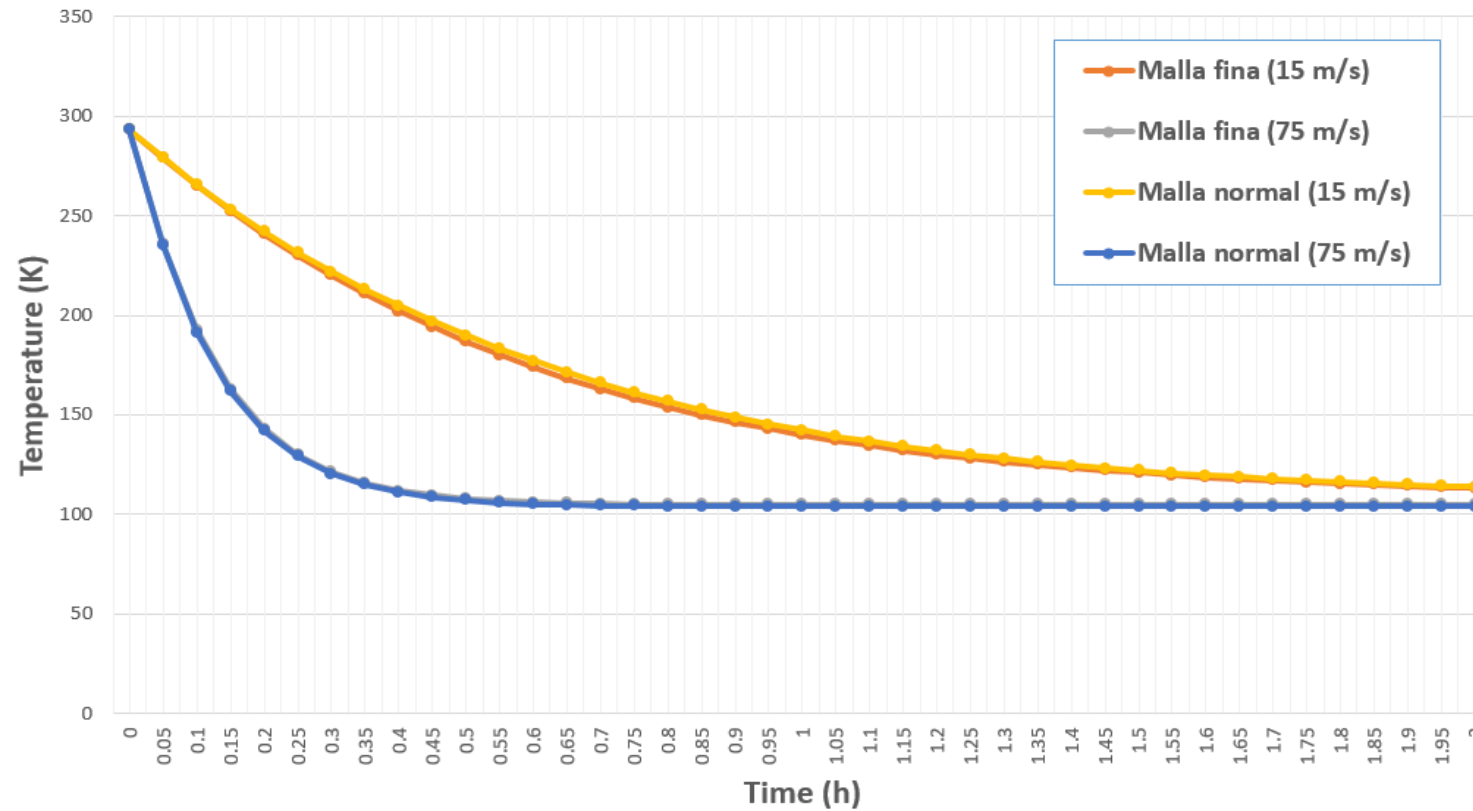
**Malla Fina**





# Malla – Refrigeración directa

EVOLUCIÓN TEMPERATURAS PORTA MUESTRAS vs TAMAÑO DE MALLA



# Estudio – Thermal Links

- Step 1: Stationary
    - Solver Configurations
      - Solution 6 (sol6)
        - Compile Equations: Stationary
        - Dependent Variables 1
          - Stationary Solver 1
            - Direct
            - Advanced
            - Segregated 1
            - AMG, fluid flow variables (spf2)
            - AMG, turbulence variables (spf2)
            - Direct, fluid flow variables (spf2)
            - Direct, turbulence variables (spf2)
  - Time dependent - Heat Transfer & Radiation
    - Step 1: Time Dependent
    - Solver Configurations
      - Solution 17 (sol17)
        - Compile Equations: Time Dependent
        - Dependent Variables 1
          - Time-Dependent Solver 1
            - Direct
            - Advanced
            - Segregated 1
            - AMG, Heat Transfer Variables
              - Direct, Heat Transfer Variables
              - GMG, Heat Transfer Variables ht (htrad1)
              - GMG, Heat Transfer Variables

## Stationary Settings

▼ Physics and Variables Selection

Modify model configuration for study step

Physics interface	Solve for	Discretization
Turbulent Flow, k-ε 2 (spf2)	<input checked="" type="checkbox"/>	Physics settings ▼
Heat Transfer in Solids and F...	<input type="checkbox"/>	Physics settings ▼
Surface-to-Surface Radiatio...	<input type="checkbox"/>	Physics settings ▼

Multiphysics couplings	Solve for
Nonisothermal Flow 1 (nitf1)	<input type="checkbox"/>
Heat Transfer with Surface-to-Surface Radiation 1 (htr...)	<input type="checkbox"/>

▼ Values of Dependent Variables

— Initial values of variables solved for —

Settings: Physics controlled ▼

— Values of variables not solved for —

Settings: Physics controlled ▼

— Store fields in output —

Settings: All ▼



Las propiedades físicas del Nitrógeno se consideran **NO DEPENDIENTES** de la temperatura.

Property	Variable	Value	Unit
Density	rho	3.4	kg/m <sup>3</sup>
Dynamic viscosity	mu	6.96e-6	Pa·s
Thermal conductivity	k_iso ; kii...	0.0098	W/(m·K)
Heat capacity at constant pressure	Cp	1040	J/(kg·K)
Ratio of specific heats	gamma	1.47	1

# Estudio – Thermal Links

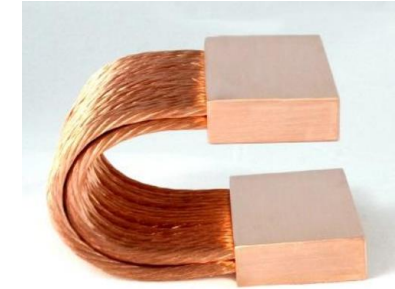
- Step 1: Stationary
    - Solver Configurations
      - Solution 6 (sol6)
        - Compile Equations: Stationary
        - Dependent Variables 1
        - Stationary Solver 1
          - Direct
          - Advanced
          - Segregated 1
          - AMG, fluid flow variables (spf2)
          - AMG, turbulence variables (spf2)
          - Direct, fluid flow variables (spf2)
          - Direct, turbulence variables (spf2)
  - Time dependent - Heat Transfer & Radiation
    - Step 1: Time Dependent
    - Solver Configurations
      - Solution 17 (sol17)
        - Compile Equations: Time Dependent
        - Dependent Variables 1
        - Time-Dependent Solver 1
          - Direct
          - Advanced
          - Segregated 1
          - AMG, Heat Transfer Variables
            - Direct, Heat Transfer Variables
          - GMG, Heat Transfer Variables ht (htrd1)
          - GMG, Heat Transfer Variables

## Time dependent Settings

Physics and Variables Selection

Modify model configuration for study step

- Global Definitions
- Component 1 (comp1)
  - Definitions
  - Turbulent Flow, k-ε 2 (spf2)
    - Fluid Properties 1
    - Initial Values 1
    - Wall 1
    - Inlet 1
    - Outlet 1
  - Heat Transfer in Solids and Fluids (ht)
    - Solid 1
    - Fluid 1
    - Initial Values 1
    - Thermal Insulation 1
    - Inflow - Inferior
    - Inflow - Derecha
    - Inflow - Izquierda
    - Inflow 2
    - Outflow 1
    - Vessel Heat Flux
  - Surface-to-Surface Radiation (rad)
    - Diffuse Surface 1
    - Initial Values 1
  - Multiphysics Couplings
    - Nonisothermal Flow 1 (nitf1)
    - Heat Transfer with Surface-to-Surface Radiation 1 (htrd1)



Values of Dependent Variables

— Initial values of variables solved for —

Settings:

— Values of variables not solved for —

Settings:

Method:

Study:

Selection:

— Store fields in output —

Settings:

# Estudio – Refrigeración Directa

- Parametric (V\_in ; P\_Res = 0 W ; T\_in = 100 K ; P\_sample = 15W)
  - Parametric Sweep
    - Step 1: Turbulent Flow Initial Conditions
    - Step 2: Time Dependent
  - Solver Configurations
    - Solution 1 (sol1)
      - Compile Equations: Turbulent Flow Initial Conditions
        - Dependent Variables 1
        - Stationary Solver 1
          - Direct
          - Advanced
          - Segregated 1
          - AMG, fluid flow variables
          - Direct, Heat Transfer Variables
          - Direct, turbulence variables (spf)
          - Direct, fluid flow variables
          - AMG, Heat Transfer Variables ht (nitf1)
          - GMG, Heat Transfer Variables ht (nitf1)
          - AMG, turbulence variables (spf)
        - Solution Store 1 (sol2)
        - Compile Equations: Time Dependent
        - Dependent Variables 2
        - Time-Dependent Solver 1
          - Direct
          - Advanced
          - Segregated 1
          - AMG, fluid flow variables
          - Direct, Heat Transfer Variables
          - Direct, turbulence variables (spf)
          - Direct, fluid flow variables
          - AMG, Heat Transfer Variables ht (nitf1)
          - GMG, Heat Transfer Variables ht (nitf1)
          - AMG, turbulence variables (spf)
    - Parametric Solutions 1 (sol3)
      - V\_in=35, T\_in=100, P\_Res=0, P\_sample=15 (sol4)
      - V\_in=55, T\_in=100, P\_Res=0, P\_sample=15 (sol5)
  - Job Configurations

## Stationary Settings

- Physics and Variables Selection
  - Modify model configuration for study step
    - Global Definitions
    - Component 1 (comp1)
      - Definitions
        - Turbulent Flow, k- $\omega$  (spf)
          - Fluid Properties 1
          - Initial Values 1
          - Wall 1
          - Inlet 1
          - Outlet 1
      - Heat Transfer in Solids and Fluids (ht)
        - Solid 1
        - Fluid 1
        - Initial Values 1
        - Thermal Insulation 1
        - Inflow - Initial Conditions
        - Inflow - T input
        - Outflow 1
        - Resistors - Heat Flux
        - Radiation - Heat Flux
        - Thermal Insulation 2
        - PCB - Heat Flux
      - Heat Transfer in Solids 2 (ht2)
        - Solid 1
        - Initial Values 1
        - Thermal Insulation 1
        - Resistors - Heat Flux
        - Radiation - Heat Flux
        - Thermal Insulation 2
        - Convective Heat Flux - Ref Power 35 m/s
        - Convective Heat Flux - Ref Power 55 m/s
        - PCB Heat Flux
    - Multiphysics Couplings
      - Nonisothermal Flow 1 (nitf1)

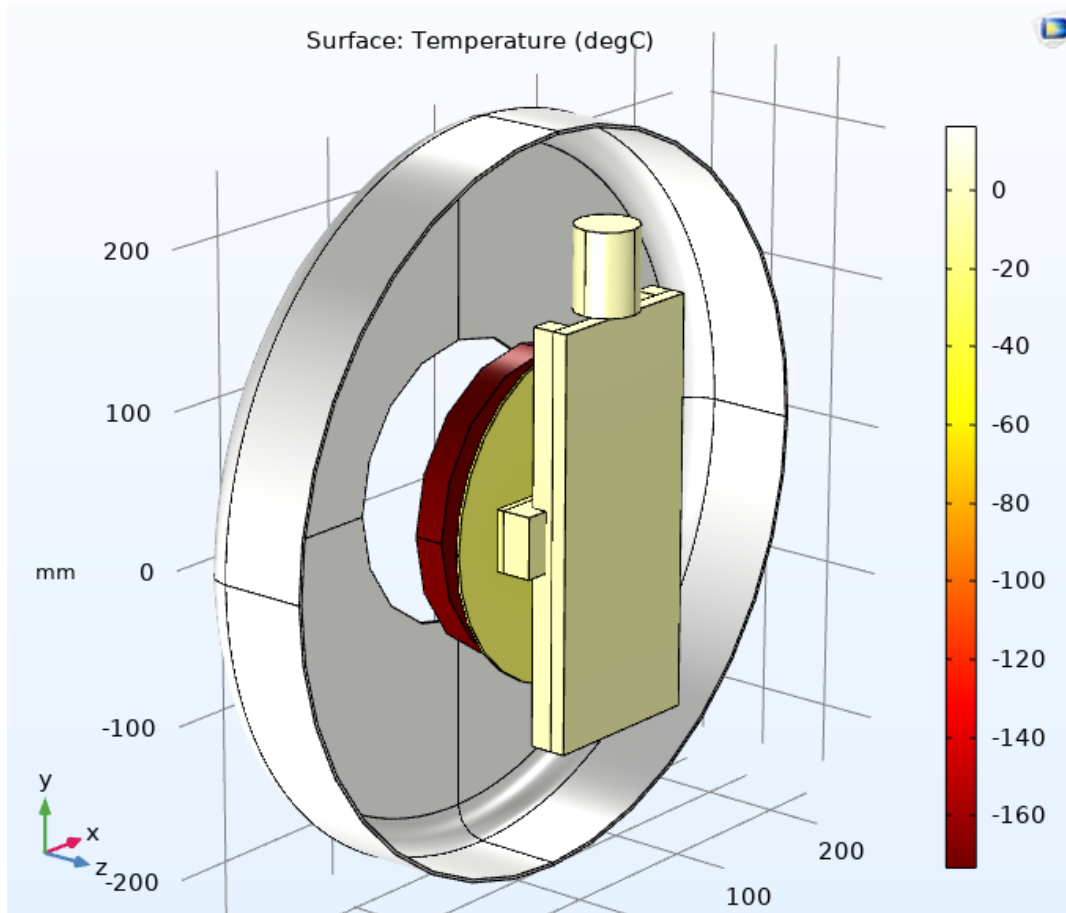


Las propiedades físicas del Nitrógeno se consideran **DEPENDIENTES** de la temperatura.

Dynamic viscosity	mu	eta(T)	Pa-s
Ratio of specific heats	gamma	1.4	1
Heat capacity at constant pressure	Cp	Cp(T)	J/(kg-K)
Density	rho	rho(p,A,T)	kg/m <sup>3</sup>
Thermal conductivity	k_iso ;...	k(T)	W/(m-K)



# Resultados – Estimación radiación térmica



Surface Integration

▢ Evaluate ▾

Label: Radiative Power Sample Holder

▾ Data

Dataset: Study 1/Solution 1 (sol1)

Selection

Selection: Manual

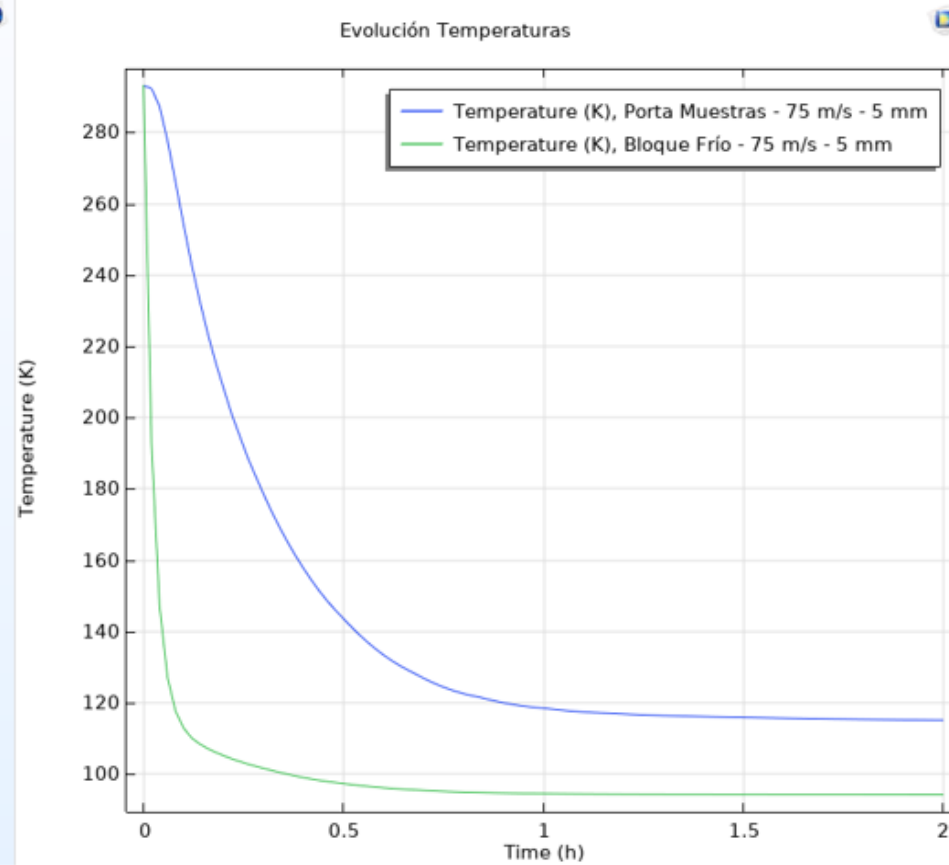
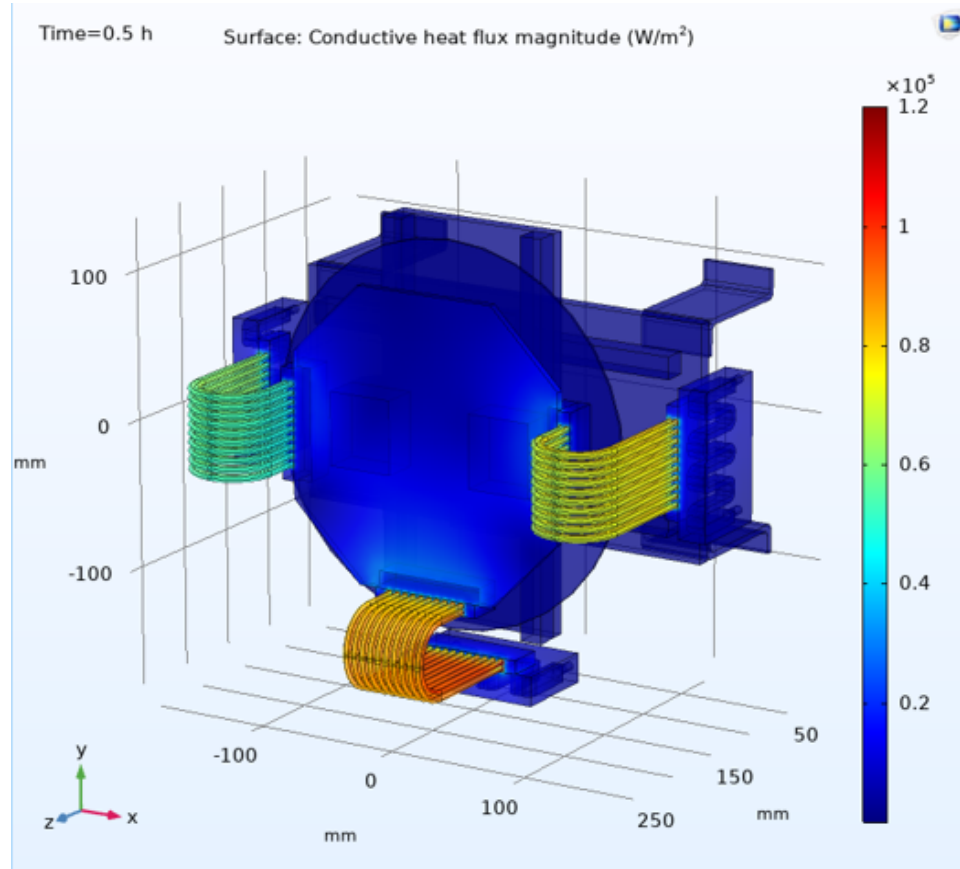
19  
20  
21  
22  
72  
77

▾ Expressions + ▾ ▾

» Expression	Unit	Description
rad.flux	W	Radiative heat flux

Radiative heat flux (W)  
13.950

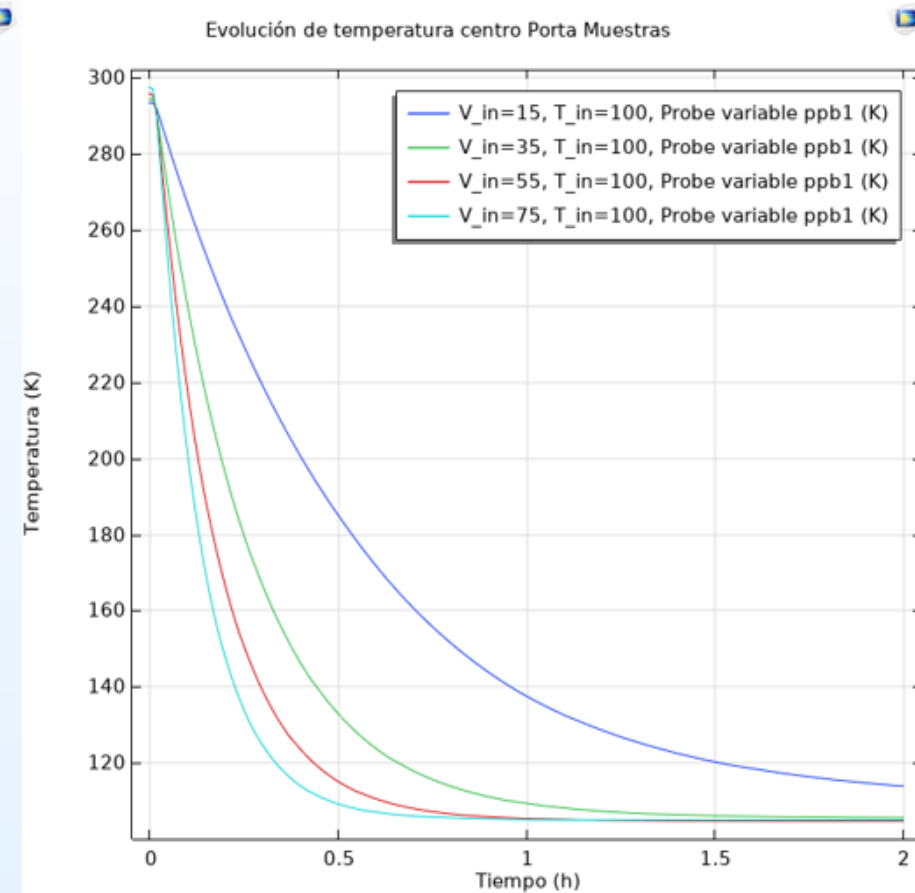
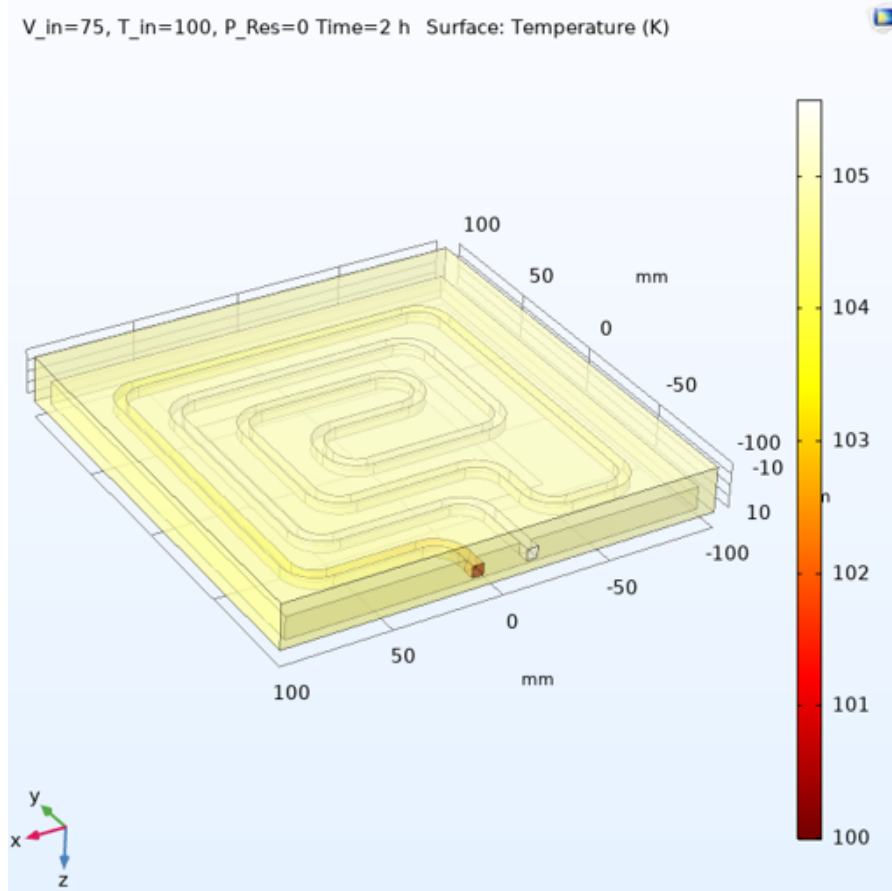
# Resultados – Thermal Links



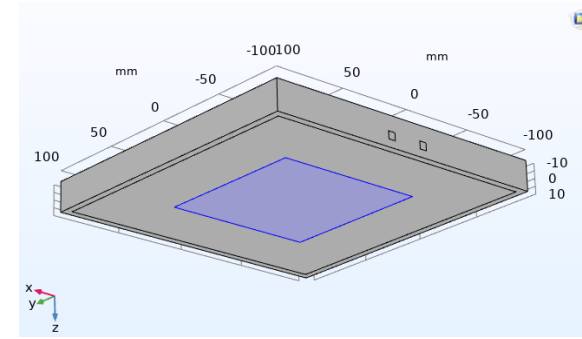




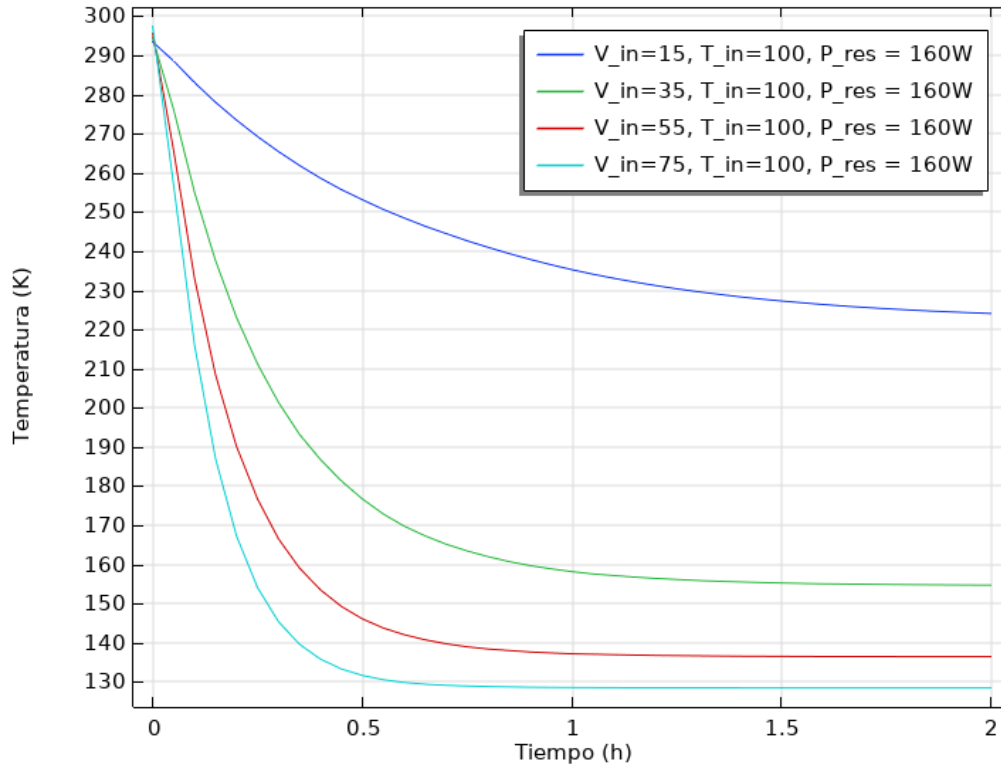
# Resultados – Refrigeración directa



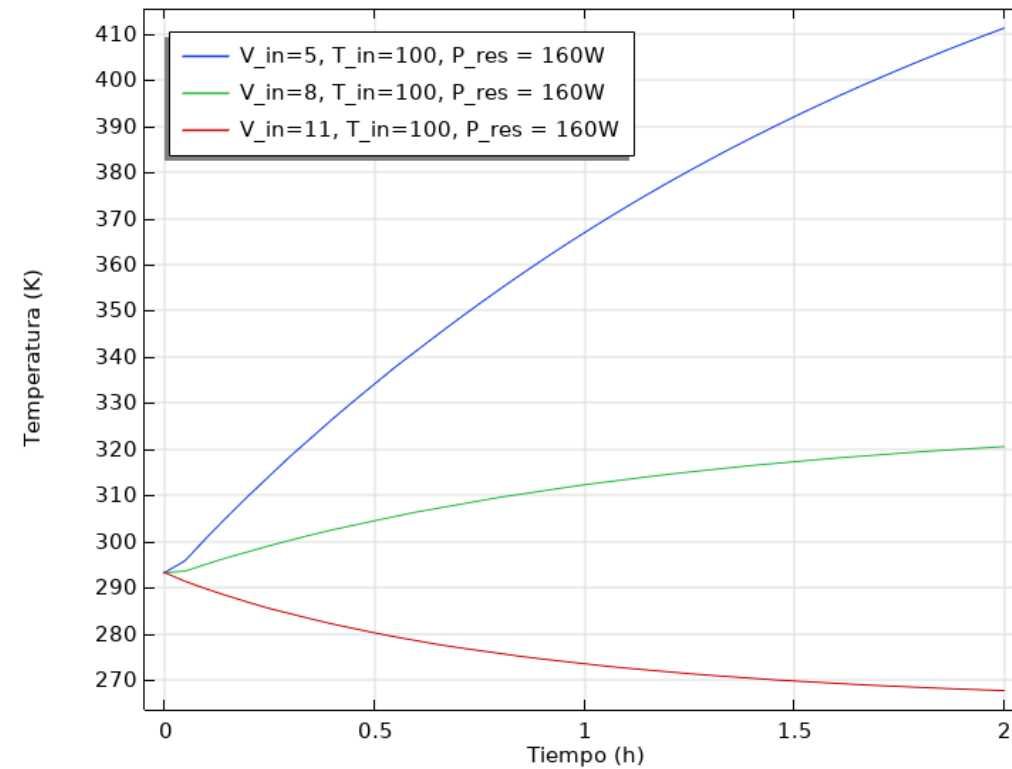
# Resultados – Refrigeración directa



Temperatura Centro Porta Muestras



Temperatura Centro Porta Muestras



## **Elección en base a los resultados**

- **A la vista de los resultados obtenidos queda descartada la opción de utilizar Thermal Links debido a los altos tiempos de enfriamiento obtenidos, lo que supondrían gastos másicos de Nitrógeno más elevados.**
- **Se decide, por lo tanto, integrar el circuito de refrigeración en el porta muestras. Con los siguientes puntos a resolver:**
  - **Encontrar tuberías metálicas lo suficientemente flexibles para integrarlas junto al sistema de traslación.**
  - **Minimizar el número de conexiones en el circuito de refrigeración.**

## Modelo simplificado

Una vez seleccionado el método de enfriamiento del Porta Muestras se pretende encontrar una simplificación del modelo que, obteniéndose los resultados más aproximados posibles al modelo completo, permita realizar simulaciones en un **tiempo considerablemente inferior**.

Para ello, se pretende sustituir la simulación del fluido turbulento por una condición de contorno en la que simplemente se indique la **potencia de refrigeración** en función de la diferencia de temperatura entre la entrada y la salida del circuito.

## Modelo simplificado

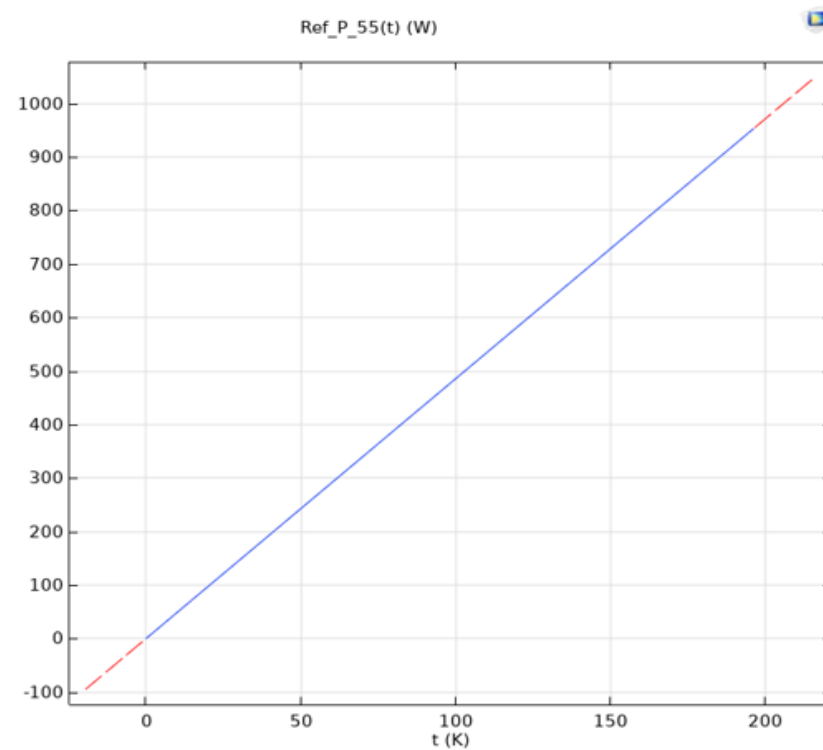
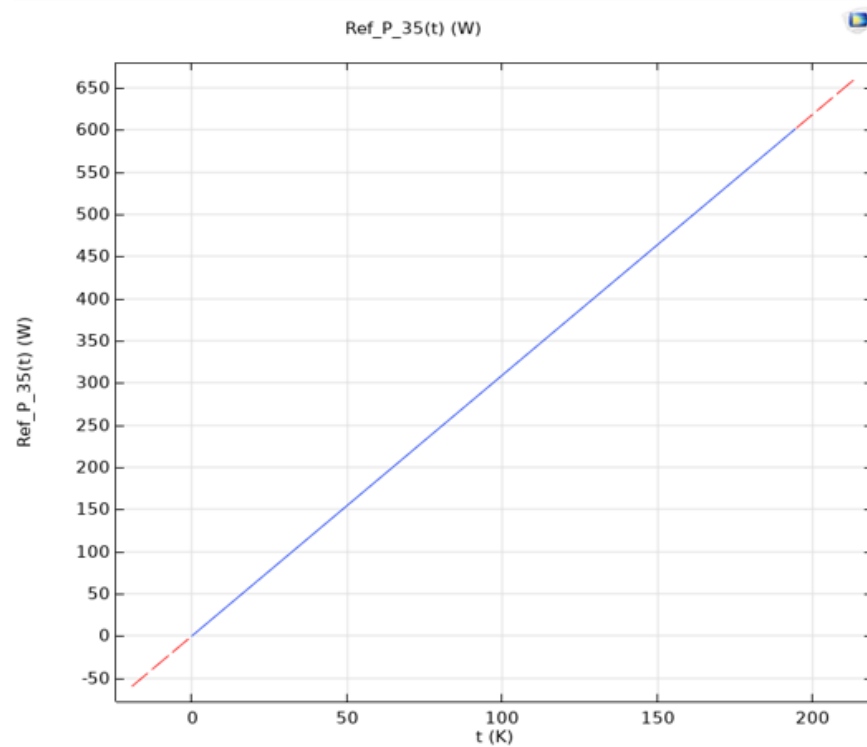
La gráfica de potencia de refrigeración con respecto a la temperatura se obtiene a partir de los resultados de temperatura del fluido a la salida del circuito de refrigeración obtenidos en el modelo completo.

$$P[W] = \dot{m} \left[ \frac{kg}{s} \right] \cdot (T_{OUT} - T_{IN})[K] \cdot C_p \left[ \frac{J}{kg \cdot K} \right]$$

$$\dot{m} \left[ \frac{kg}{s} \right] = S[m^2] \cdot V_s \left[ \frac{m}{s} \right] \cdot \rho \left[ \frac{kg}{m^3} \right]$$

## Modelo simplificado

Una vez obtenida la función  $P(T_{out}-T_{in})$ , se introduce en COMSOL como una función de interpolación.



## Modelo simplificado

Utilizando la interfaz física “Heat Transfer in Solids”, se introducen estas funciones como condiciones de contorno “Heat Flux”.

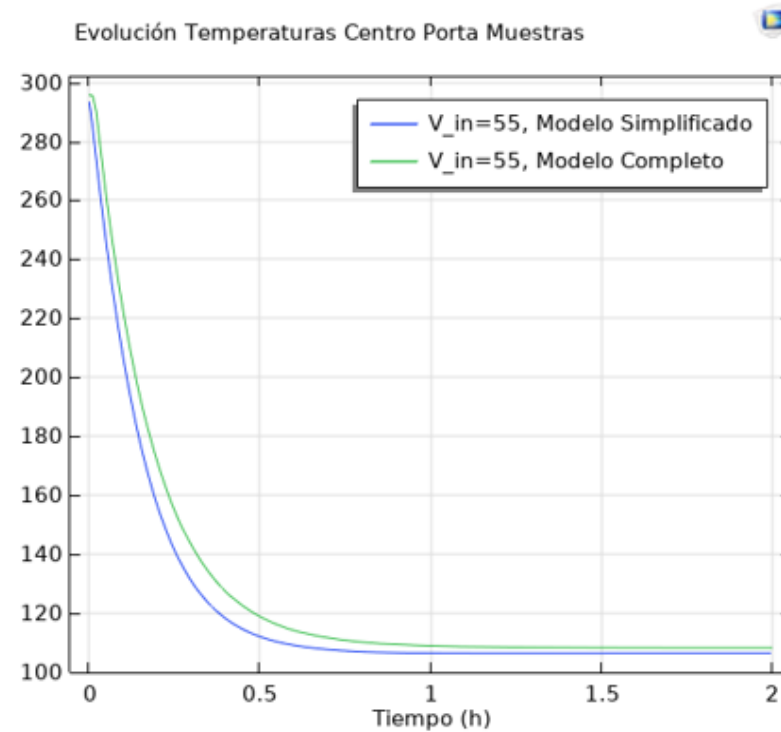
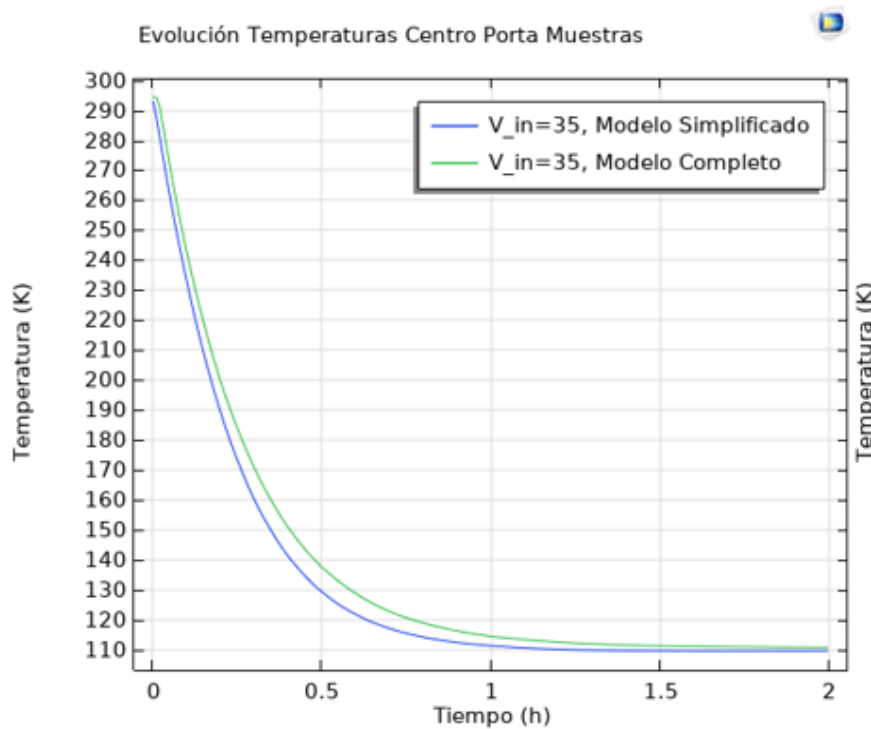
The image shows a software interface for defining boundary conditions. On the left, a tree view shows a model named 'Heat Transfer in Solids 2 (ht2)' with several sub-entities: 'Solid 1', 'Initial Values 1', 'Thermal Insulation 1', 'Resistors - Heat Flux', 'Radiation - Heat Flux', 'Thermal Insulation 2', 'Convective Heat Flux - Ref Power 35 m/s', 'Convective Heat Flux - Ref Power 55 m/s', and 'PCB Heat Flux'. A blue line connects the 'Convective Heat Flux - Ref Power 35 m/s' entity to a detailed configuration window on the right.

The configuration window is titled 'Heat Flux' and contains the following options and formulas:

- General inward heat flux
- Convective heat flux
- $q_0 = h \cdot (T_{\text{ext}} - T_2)$
- Heat rate
- $q_0 = \frac{P_0}{A}$
- $P_0$   W

## Modelo simplificado

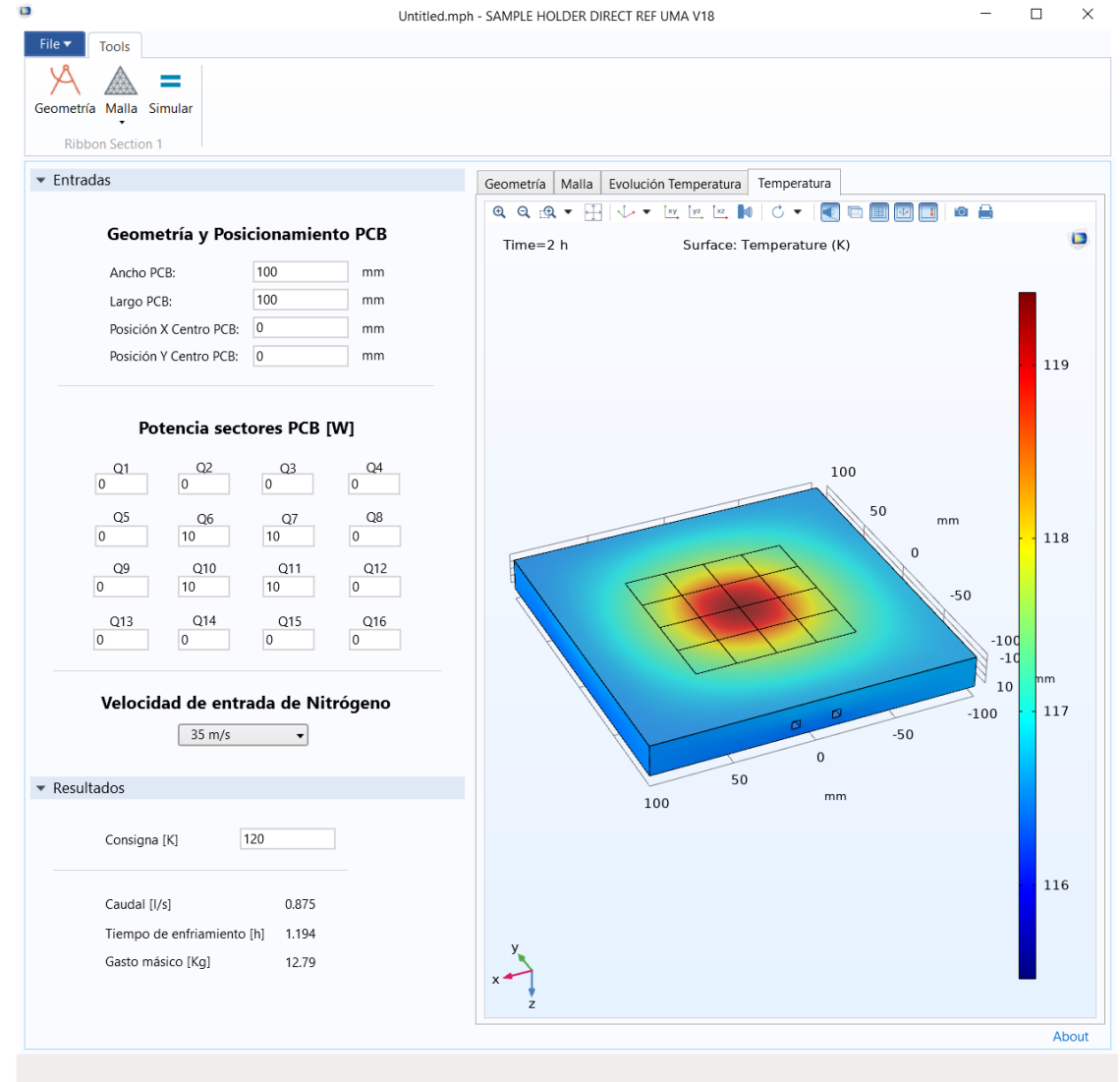
Los resultados obtenidos se ajustan con bastante exactitud a la solución obtenida con el modelo completo.





# Aplicación

- Permite realizar simulaciones rápidas de curvas de enfriamiento y cálculos de gasto másico de Nitrógeno en función de las características de la PCB a testear.
- Cómo parámetros de entrada están las dimensiones de la PCB, la potencia calorífica generada por sus componentes y la velocidad de entrada de fluido.
- Como datos de salida se tienen las gráficas de distribución de temperatura y curvas de enfriamiento, y los datos calculados de Caudal, Tiempo de enfriamiento y Gasto másico de nitrógeno.



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